



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 60 Volts CURRENT 3 Ampere

CHM6426XPT

Lead free devices

APPLICATION

- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

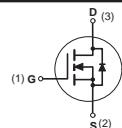
FEATURE

- * Small package. (SC-62/SOT-89)
- * High density cell design for extremely low R_{DSON}.
- * Rugged and reliable.

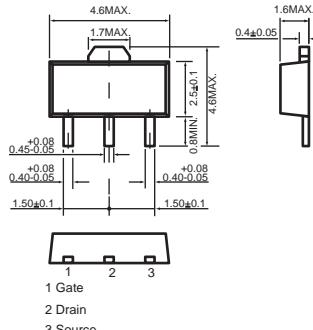
CONSTRUCTION

- * N-Channel Enhancement

CIRCUIT



SC-62/SOT-89



Dimensions in millimeters

SC-62/SOT-89

Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Symbol	Parameter	CHM6426XPT	Units
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Maximum Drain Current - Continuous	3	A
	- Pulsed (Note 3)	12	
P _D	Maximum Power Dissipation	1300	mW
T _J	Operating Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

Note : 1. Surface Mounted on FR4 Board , t <=10sec

2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%

3. Repetitive Rating , Pulse width limited by maximum junction temperature

4. Guaranteed by design , not subject to production testing

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1)	100	°C/W
2008-03			

ELECTRICAL CHARACTERISTIC (CHM6426XPT)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
$I_{\text{DS}(\text{SS})}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 60 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
I_{GSSF}	Gate-Body Leakage	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
I_{GSSR}	Gate-Body Leakage	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

ON CHARACTERISTICS (Note 2)

$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	1		3	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}, I_D=3\text{A}$		75	90	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_D=2.4\text{A}$		88	110	

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		665		pF
C_{oss}	Output Capacitance			75		
C_{rss}	Reverse Transfer Capacitance			40		

SWITCHING CHARACTERISTICS (Note 4)

Q_g	Total Gate Charge	$V_{\text{DS}}=30\text{V}, I_D=3\text{A}$ $V_{\text{GS}}=10\text{V}$		13.4	17.8	nC
Q_{gs}	Gate-Source Charge			1.7		
Q_{gd}	Gate-Drain Charge			2.8		
t_{on}	Turn-On Time	$V_{\text{DD}}= 30\text{V}$ $I_D = 1.0\text{A}, V_{\text{GS}}= 10 \text{ V}$ $R_{\text{GEN}}= 6 \Omega$		13	26	nS
t_r	Rise Time			4	8	
t_{off}	Turn-Off Time			33	66	
t_f	Fall Time			3	6	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I_s	Drain-Source Diode Forward Current	(Note 1)			3.0	A
V_{SD}	Drain-Source Diode Forward Voltage	$I_s = 3\text{A}, V_{\text{GS}} = 0 \text{ V}$			1.1	V

RATING CHARACTERISTIC CURVES (CHM6426XPT)

Typical Electrical Characteristics

Figure 1. Output Characteristics

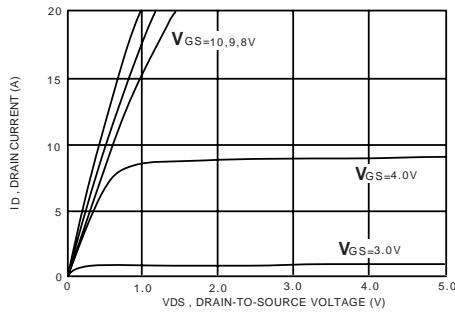


Figure 2. Transfer Characteristics

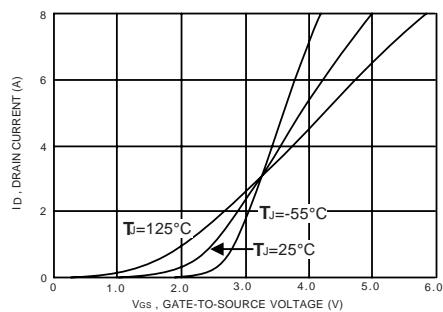


Figure 3. Gate Charge

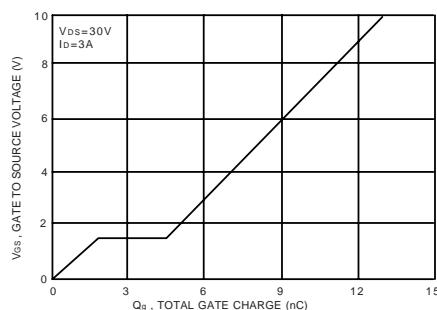


Figure 4. On-Resistance Variation with Temperature

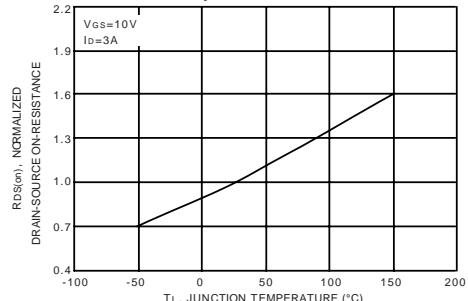


Figure 5. Gate Threshold Variation with Temperature

